

**INVENTORSHIP DECLARATION BY SOLE INVENTOR**

I, Larry D. Kinsman, HEREBY DECLARE THAT:

My residence, mailing address, and citizenship are stated below next to my name.

I believe I am the original, first, and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled

MICROELECTRONIC DEVICES AND
METHODS FOR PACKAGING MICROELECTRONIC DEVICES

the specification of which:

☒ is attached hereto.

☐ was filed on _____ as Application Serial No. _____ and was amended on _____ (if applicable).

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 C.F.R. §1.56, including, for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim priority benefits under 35 U.S.C. §119(a)-(d) or (f), §172, or §365(a)-(b) of any foreign or international application(s) for patent or inventor's certificate listed below in Table 1 and have also identified in Table 1 any such foreign or international application having a filing date before that of the application of which priority is claimed.

I hereby declare that all statements made herein of my knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. I understand that the execution of this document does not in itself establish an attorney-client relationship between the undersigned and Perkins Coie, LLP, or any of its attorneys.

Full name of Sole inventor: Larry D. Kinsman

Citizenship: USA Mailing Address: 5160 E. Kiwi Court
Kuna, Idaho 83634

Residence (if different): _____

Inventor's Signature: Ray Ki Date: 8/27/03

Table 1

<u>Country</u>	<u>App. No.</u>	<u>Filing Date</u>	<u>Priority Not Claimed</u>
			<input type="checkbox"/>
			<input type="checkbox"/>
			<input type="checkbox"/>



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P.O. Box 1450
Alexandria, VA 22313-1450

DOCKETED

DTD:spw

SENT: September 18, 2003
NEW APPLICATION

PLEASE STAMP WITH APPLICATION NO. AND RETURN

Please acknowledge receipt of the below-listed documents by placing your receiving stamp hereon and mailing:

Check; PTO/SB/05; PTO/SB/17 (+ copy); Specification, Claims, Abstract (23 pages); Formal Drawings (6 sheets, FIGS. 1-8); Form PTO-1595 and Assignment (3 pages); Declaration: (2 pages); Power of Attorney with copy of Assignment (5 pages); General Authorization for Extensions of Time.
in re: Larry D. Kinsman; for MICROELECTRONIC DEVICES AND METHODS FOR PACKAGING MICROELECTRONIC DEVICES.

JS

Perkins Coie LLP

03970 U.S. PTO
10/665912
09/18/03